# 74AHC138-Q100; 74AHCT138-Q100

3-to-8 line decoder/demultiplexer; inverting

**Rev. 4 — 4 September 2023** 

Product data sheet

### 1. General description

The 74AHC138-Q100; 74AHCT138-Q100 are high-speed Si-gate CMOS devices and are pin compatible with Low power Schottky TTL (LSTTL). They are specified in compliance with JEDEC standard No. 7A.

The 74AHC138-Q100; 74AHCT138-Q100 is a 3-to-8 line decoder/demultiplexer. It accepts three binary weighted address inputs (A0, A1 and A2) and, when enabled, provides eight mutually exclusive outputs ( $\overline{Y}0$  to  $\overline{Y}7$ ) that are LOW when selected.

There are three enable inputs: two active LOW ( $\overline{E}1$  and  $\overline{E}2$ ) and one active HIGH (E3). Every output will be HIGH unless  $\overline{E}1$  and  $\overline{E}2$  are LOW and E3 is HIGH.

This multiple enable function allows easy parallel expansion of the device to a 1-of-32 (5 lines to 32 lines) decoder with just four 74AHC138-Q100; 74AHCT138-Q100 devices and one inverter. The 74AHC138-Q100; 74AHCT138-Q100 can be used as an eight output demultiplexer by using one of the active LOW enable inputs as the data input and the remaining enable inputs as strobes. Unused enable inputs must be permanently tied to their appropriate active HIGH or LOW state.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

#### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Balanced propagation delays
- All inputs have Schmitt-trigger action
- · Demultiplexing capability
- Multiple input enable for easy expansion
- Ideal for memory chip select decoding
- Inputs accepts voltages higher than V<sub>CC</sub>
- For 74AHC138-Q100 only: operates with CMOS input levels
- For 74AHCT138-Q100 only: operates with TTL input levels
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Multiple package options
- DHVQFN package with Side-Wettable Flanks enabling Automatic Optical Inspection (AOI) of solder joints

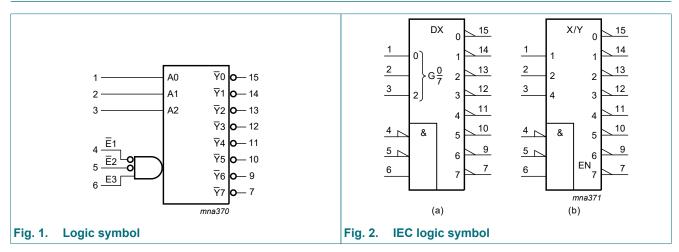


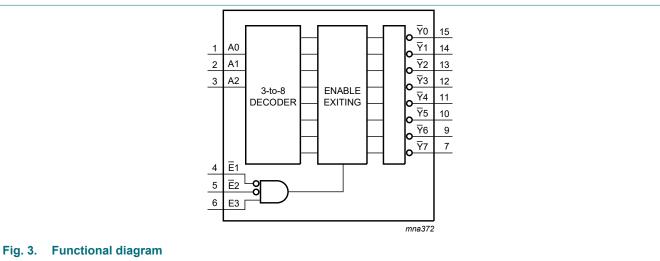
### 3. Ordering information

**Table 1. Ordering information** 

Type number	Package											
	Temperature range	Name	Description	Version								
74AHC138D-Q100 74AHCT138D-Q100	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1								
74AHC138PW-Q100 74AHCT138PW-Q100	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1								
74AHC138BQ-Q100 74AHCT138BQ-Q100	-40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 × 3.5 × 0.85 mm	SOT763-1								

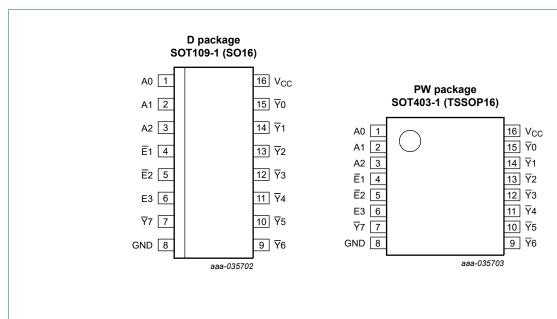
### 4. Functional diagram



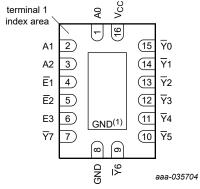


### 5. Pinning information

#### 5.1. Pinning



#### BQ package SOT763-1 (DHVQFN16)



Transparent top view

(1) This is not a ground pin. There is no electrical or mechanical requirement to solder the pad. In case soldered, the solder land should remain floating or connected to GND.

### 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
A0	1	address input
A1	2	address input
A2	3	address input
E1	4	enable input (active LOW)
E2	5	enable input (active LOW)
E3	6	enable input (active HIGH)
GND	8	ground (0 V)
$\overline{Y}0, \overline{Y}1, \overline{Y}2, \overline{Y}3, \overline{Y}4, \overline{Y}5, \overline{Y}6, \overline{Y}7$	15, 14, 13, 12, 11, 10, 9, 7	output
V <sub>CC</sub>	16	supply voltage

## 6. Functional description

#### Table 3. Function table

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care.$ 

Input						Output										
E1	E2	E3	A0	A1	A2	<b>∀</b> 0	<b>₹</b> 1	<b>∀</b> 2	<b>∀</b> 3	<b>∀</b> 4	<b>∀</b> 5	<b>∀</b> 6	<b>Y</b> 7			
Н	Х	Х	Х	X	X	Н	Н	Н	Н	Н	Н	Н	Н			
X	Н	Х	Х	X	Х	Н	Н	Н	Н	Н	Н	Н	Н			
Х	Х	L	Х	Х	Х	Н	Н	Н	Н	Н	Н	Н	Н			
L	L	Н	L	L	L	L	Н	Н	Н	Н	Н	Н	Н			
L	L	Н	Н	L	L	Н	L	Н	Н	Н	Н	Н	Н			
L	L	Н	L	Н	L	Н	Н	L	Н	Н	Н	Н	Н			
L	L	Н	Н	Н	L	Н	Н	Н	L	Н	Н	Н	Н			
L	L	Н	L	L	Н	Н	Н	Н	Н	L	Н	Н	Н			
L	L	Н	Н	L	Н	Н	Н	Н	Н	Н	L	Н	Н			
L	L	Н	L	Н	Н	Н	Н	Н	Н	Н	Н	L	Н			
L	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L			

### 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+7.0	V
VI	input voltage			-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < -0.5 V	[1]	-20	-	mA
I <sub>OK</sub>	output clamping current	$V_{O}$ < -0.5 V or $V_{O}$ > $V_{CC}$ + 0.5 V	[1]	-	±20	mA
I <sub>O</sub>	output current	$V_O = -0.5 \text{ V to } (V_{CC} + 0.5 \text{ V})$		-	±25	mA
I <sub>CC</sub>	supply current			-	75	mA
I <sub>GND</sub>	ground current			-75	-	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +125 °C	[2]	-	500	mW

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

### 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	74A	HC138-0	Q100	74AI	Q100	Unit	
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	5.5	4.5	5.0	5.5	V
V <sub>I</sub>	input voltage		0	-	5.5	0	-	5.5	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$	-	-	100	-	-	-	ns/V
	fall rate	$V_{CC} = 5.0 \text{ V} \pm 0.5 \text{ V}$	-	-	20	-	-	20	ns/V

#### 9. Static characteristics

#### **Table 6. Static characteristics**

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	Unit			
			Min	Тур	Max	Min	Max	Min	Max			
74AHC138-Q100												
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	-	-	1.5	-	1.5	-	V		
	input voltage	V <sub>CC</sub> = 3.0 V	2.1	-	-	2.1	-	2.1	-	V		
		V <sub>CC</sub> = 5.5 V	3.85	-	-	3.85	-	3.85	-	V		
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 2.0 V	-	-	0.5	-	0.5	-	0.5	V		
	input voltage	V <sub>CC</sub> = 3.0 V	-	-	0.9	-	0.9	-	0.9	V		
		V <sub>CC</sub> = 5.5 V	-	-	1.65	-	1.65	-	1.65	V		

<sup>[2]</sup> For SOT109-1 (SO16) package: P<sub>tot</sub> derates linearly with 12.4 mW/K above 110 °C. For SOT403-1 (TSSOP16) package: P<sub>tot</sub> derates linearly with 8.5 mW/K above 91 °C. For SOT763-1 (DHVQFN16) package: P<sub>tot</sub> derates linearly with 11.2 mW/K above 106 °C.

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	Unit	
			Min	Тур	Max	Min	Max	Min	Max	
V <sub>OH</sub>	HIGH-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	output voltage	I <sub>O</sub> = -50 μA; V <sub>CC</sub> = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I <sub>O</sub> = -50 μA; V <sub>CC</sub> = 3.0 V	2.9	3.0	-	2.9	-	2.9	-	V
		I <sub>O</sub> = -50 μA; V <sub>CC</sub> = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 3.0 V	2.58	-	-	2.48	-	2.4	-	V
		I <sub>O</sub> = -8.0 mA; V <sub>CC</sub> = 4.5 V	3.94	-	-	3.8	-	3.7	-	V
V <sub>OL</sub>	LOW-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	output voltage	I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 3.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
	$I_{O} = 4.0 \text{ mA; } V_{CC} = 3.0 \text{ V}$		-	-	0.36	-	0.44	-	0.55	V
	$I_{O} = 8.0 \text{ mA; } V_{CC} = 4.5 \text{ V}$		-	-	0.36	-	0.44	-	0.55	V
I <sub>I</sub>	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V or 5.5 V	-	-	0.1	-	1.0	-	2.0	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	4.0	-	40	-	80	μΑ
C <sub>I</sub>	input capacitance		-	3.0	10	-	10	-	10	pF
74AHCT	138-Q100					l	'	ı	1	
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	-	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	0.8	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = -50 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -8.0 mA	3.94	-	-	3.8	-	3.7	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 V$								
	output voltage	Ι <sub>Ο</sub> = 50 μΑ	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 8.0 mA	-	-	0.36	-	0.44	-	0.55	V
I <sub>I</sub>	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V or 5.5 V	-	-	0.1	-	1.0	-	2.0	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	4.0	-	40	-	80	μΑ
ΔI <sub>CC</sub>	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V}; I_O = 0 \text{ A};$ other pins at $V_{CC}$ or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V	-	-	1.35	-	1.5	-	1.5	mA
C <sub>I</sub>	input capacitance		-	3.0	10	-	10	-	10	pF

## 10. Dynamic characteristics

#### **Table 7. Dynamic characteristics**

GND = 0 V; for test circuit see Fig. 6.

Symbol	Parameter	Conditions			25 °C		-40 °C t	o +85 °C	-40 °C to	o +125 °C	Unit
				Min	Typ[1]	Max	Min	Max	Min	Max	
74AHC1	38-Q100								ı		1
t <sub>pd</sub>	propagation	An to √n; see Fig. 4	[2]								
	delay	V <sub>CC</sub> = 3.0 V to 3.6 V									
		C <sub>L</sub> = 15 pF		-	6.0	11.4	1.0	13.0	1.0	14.5	ns
		C <sub>L</sub> = 50 pF		-	8.6	15.8	1.0	18.0	1.0	20.0	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V									
		C <sub>L</sub> = 15 pF		-	4.4	8.1	1.0	9.5	1.0	10.5	ns
		C <sub>L</sub> = 50 pF		-	6.3	10.1	1.0	11.5	1.0	13.0	ns
		E3 to $\overline{Y}$ n; see $\underline{\text{Fig. 4}}$	[2]								
		V <sub>CC</sub> = 3.0 V to 3.6 V									
		C <sub>L</sub> = 15 pF		-	5.8	12.8	1.0	15.0	1.0	16.0	ns
		C <sub>L</sub> = 50 pF		-	8.2	16.3	1.0	18.5	1.0	20.5	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V									
		C <sub>L</sub> = 15 pF		-	4.2	8.1	1.0	9.5	1.0	10.5	ns
		C <sub>L</sub> = 50 pF		-	6.0	10.1	1.0	11.5	1.0	13.0	ns
		E1, E2 to ∀n; see Fig. 5	[2]								
		V <sub>CC</sub> = 3.0 V to 3.6 V									
		C <sub>L</sub> = 15 pF		-	5.7	11.4	1.0	13.5	1.0	14.5	ns
		C <sub>L</sub> = 50 pF		-	8.2	14.9	1.0	17.0	1.0	19.0	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V									
		C <sub>L</sub> = 15 pF		-	4.2	8.1	1.0	9.5	1.0	10.5	ns
		C <sub>L</sub> = 50 pF		-	6.0	10.1	1.0	11.5	1.0	13.0	ns
C <sub>PD</sub>	power dissipation capacitance	$C_L$ = 50 pF; $f_i$ = 1 MHz; $V_I$ = GND to $V_{CC}$	[3]	-	18.0	-	-	-	-	-	pF
74AHCT	138-Q100		'					1			
t <sub>pd</sub>	propagation	An to $\overline{Y}$ n; see Fig. 4	[2]								
	delay	V <sub>CC</sub> = 4.5 V to 5.5 V									
		C <sub>L</sub> = 15 pF		-	4.4	10.4	1.0	12.0	1.0	13.0	ns
		C <sub>L</sub> = 50 pF		-	6.2	11.4	1.0	13.0	1.0	14.5	ns
		E3 to $\overline{Y}$ n; see $\underline{\text{Fig. 4}}$	[2]								
		V <sub>CC</sub> = 4.5 V to 5.5 V									
		C <sub>L</sub> = 15 pF		-	4.3	9.1	1.0	10.5	1.0	11.5	ns
		C <sub>L</sub> = 50 pF		-	6.2	10.1	1.0	11.5	1.0	13.0	ns
		E1, E2 to Yn; see Fig. 5	[2]								
		V <sub>CC</sub> = 4.5 V to 5.5 V									
		C <sub>L</sub> = 15 pF		-	4.3	9.6	1.0	11.0	1.0	12.0	ns
		C <sub>L</sub> = 50 pF		_	6.2	10.6	1.0	12.0	1.0	13.5	ns

Symbol	Parameter	Conditions		25 °C			+85 °C	-40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	Min	Max	
C <sub>PD</sub>		$C_L$ = 50 pF; $f_i$ = 1 MHz; [3] $V_I$ = GND to $V_{CC}$	-	23.0	-	-	-	-	-	pF

- Typical values are measured at nominal supply voltage ( $V_{CC}$  = 3.3 V and  $V_{CC}$  = 5.0 V).
- $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

f<sub>i</sub> = input frequency in MHz, f<sub>o</sub> = output frequency in MHz

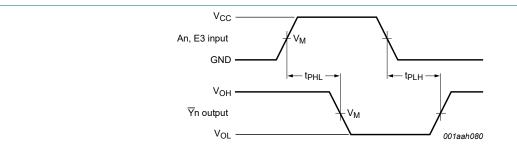
C<sub>L</sub> = output load capacitance in pF

V<sub>CC</sub> = supply voltage in V

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_0)$  = sum of the outputs.

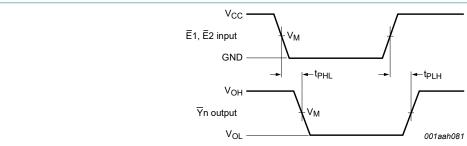
#### 10.1. Waveforms and test circuit



Measurement points are given in Table 8.

V<sub>OL</sub> and V<sub>OH</sub> are typical voltage output levels that occur with the output load.

The inputs An, E3 to outputs  $\overline{Y}n$  propagation delays Fig. 4.



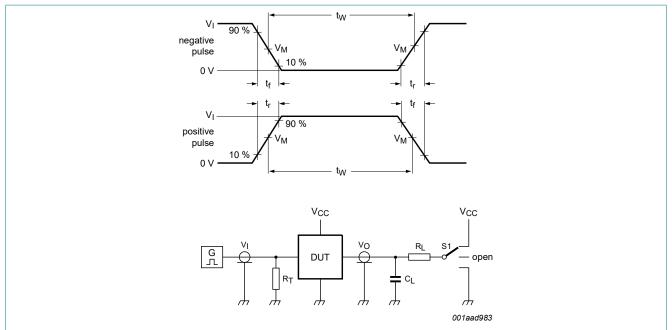
Measurement points are given in <u>Table 8</u>.

V<sub>OL</sub> and V<sub>OH</sub> are typical voltage output levels that occur with the output load.

The inputs En to outputs Yn propagation delays

**Table 8. Measurement points** 

Туре	Input	Output
	V <sub>M</sub>	V <sub>M</sub>
74AHC138-Q100	0.5 × V <sub>CC</sub>	0.5 × V <sub>CC</sub>
74AHCT138-Q100	1.5 V	0.5 × V <sub>CC</sub>



Test data is given in Table 9.

Definitions test circuit:

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator;

C<sub>L</sub> = Load capacitance including jig and probe capacitance;

R<sub>L</sub> = Load resistance;

S1 = Test selection switch.

#### Fig. 6. Test circuit for measuring switching times

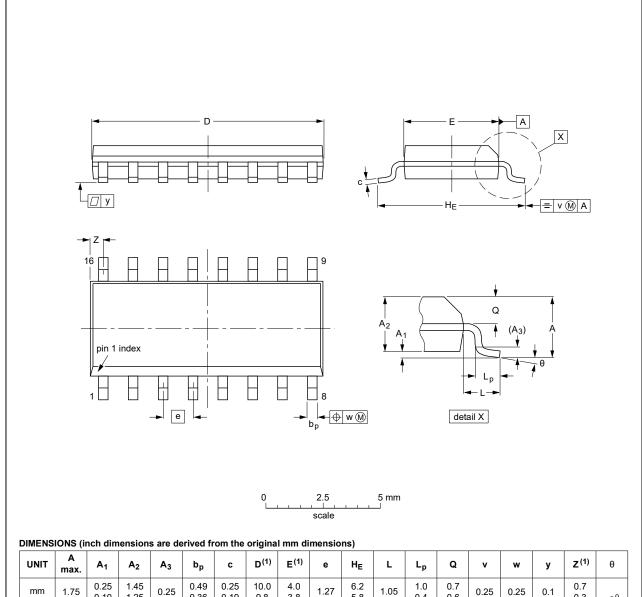
Table 9. Test data

Туре	Input		Load		S1 position				
	V <sub>I</sub>	t <sub>r</sub> , t <sub>f</sub>	CL	$R_L$	t <sub>PHL</sub> , t <sub>PLH</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>		
74AHC138-Q100	V <sub>CC</sub>	≤ 3.0 ns	15 pF, 50 pF	1 kΩ	open	GND	V <sub>CC</sub>		
74AHCT138-Q100	3.0 V ≤ 3.0 ns		15 pF, 50 pF		open	GND	V <sub>CC</sub>		

### 11. Package outline

#### SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



	UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	V	w	у	Z <sup>(1)</sup>	θ
	mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
i	nches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

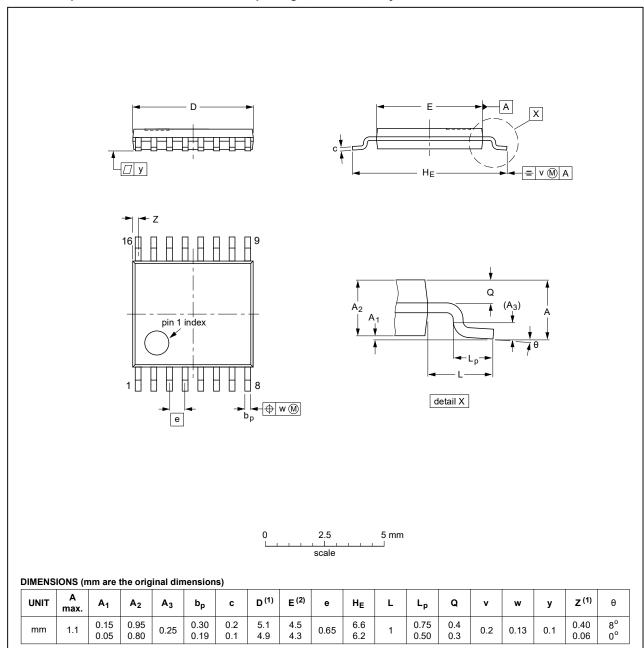
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT109-1	076E07	MS-012				<del>99-12-27</del> 03-02-19

Fig. 7. Package outline SOT109-1 (SO16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT403-1		MO-153				<del>99-12-27</del> 03-02-18

Fig. 8. Package outline SOT403-1 (TSSOP16)

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

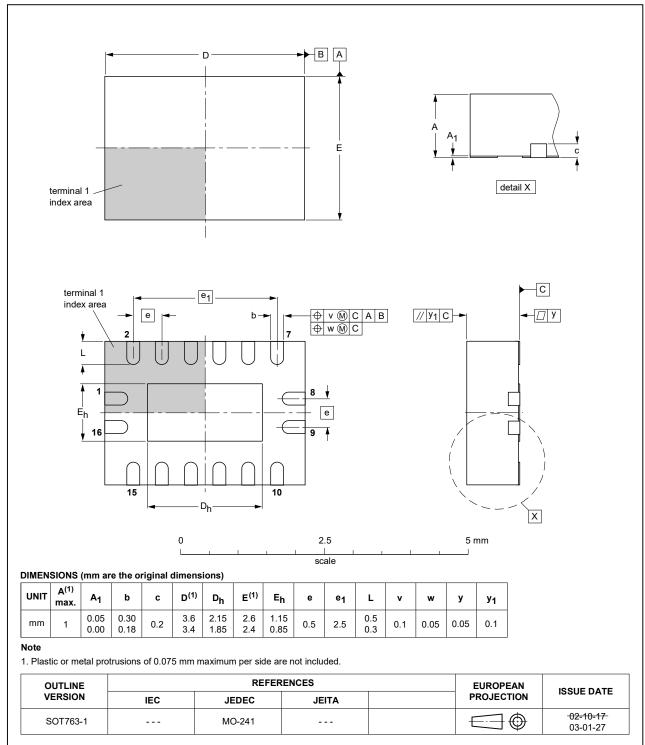


Fig. 9. Package outline SOT763-1 (DHVQFN16)

### 12. Abbreviations

#### **Table 10. Abbreviations**

Acronym	Description
CDM	Charged-Device Model
CMOS	Complementary Metal Oxide Semiconductor
LSTTL	Low-power Schottky Transistor-Transistor Logic
ESD	ElectroStatic Discharge
HBM	Human Body Model
TTL	Transistor-Transistor Logic

## 13. Revision history

#### **Table 11. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes		
74AHC_AHCT138_Q100 v.4	20230904	Product data sheet	-	74AHC_AHCT138_Q100 v.3		
Modifications:	<u>Section 2</u> : ESD specification updated according to the latest JEDEC standard.					
74AHC_AHCT138_Q100 v.3	20200910	Product data sheet	-	74AHC_AHCT138_Q100 v.2		
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Section 2 updated.</li> <li>Table 4: Derating values for P<sub>tot</sub> total power dissipation have been updated.</li> </ul>					
74AHC_AHCT138_Q100 v.2	20140402	Product data sheet	-	74AHC_AHCT138_Q100 v.1		
Modifications:	<ul> <li>Description for t<sub>pd</sub> for the 74AHCT138-Q100 corrected (errata) in <u>Table 7</u>.</li> </ul>					
74AHC_AHCT138_Q100 v.1	20130326	Product data sheet	-	-		

### 14. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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Product data sheet

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For more information, please visit: http://www.nexperia.com For sales office addresses, please send an email to: salesaddresses@nexperia.com Date of release: 4 September 2023

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